

65V N-Channel Enhancement Mode MOSFET

Description

The AP80N06D uses advanced **APM-SGT₁₁** technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = 65V$ $I_D = 80A$

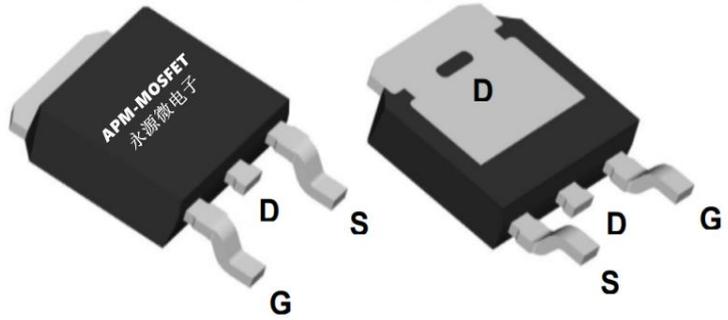
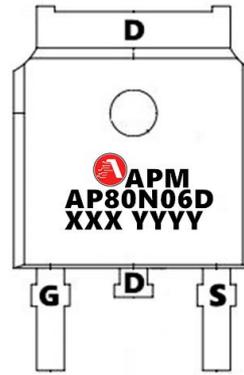
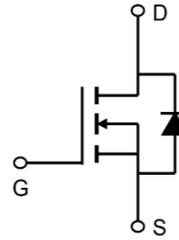
$R_{DS(ON)} < 8.5m\Omega$ @ $V_{GS}=10V$ (Type: **6.5m Ω**)

Application

Battery protection

Load switch

Uninterruptible power supply



Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|------------|-----------|--------------------|----------|
| AP80N06D | TO-252-3L | AP80N06D XXX YYYYY | 2500 |

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Value | Unit |
|----------------------|--|------------|--------------|
| V_{DS} | Drain source voltage | 65 | V |
| V_{GS} | Gate source voltage | ± 20 | V |
| $I_D@T_A=25^\circ C$ | Continuous drain current | 80 | A |
| $I_D@T_A=70^\circ C$ | Continuous drain current | 44 | A |
| I_{DM} | Pulsed drain current | 280 | A |
| $PD@T_A=25^\circ C$ | Power dissipation | 73.5 | W |
| EAS | Single pulsed avalanche energy | 57.5 | mJ |
| TSTG | Storage Temperature Range | -55 to 150 | $^\circ C$ |
| T_j | Operation and storage temperature | -55 to 150 | $^\circ C$ |
| $R_{\theta JC}$ | Thermal resistance, junction-case | 1.7 | $^\circ C/W$ |
| $R_{\theta JA}$ | Thermal resistance, junction-ambient5) | 62.5 | $^\circ C/W$ |



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Electrical Characteristics (T_J=25°C, unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------------|---|---|------|------|------|------|
| V(BR)DSS | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250μA | 65 | 72 | - | V |
| IGSS | Gate-body Leakage Current | V _{DS} =0V, V _{GS} =±20V | - | - | ±100 | nA |
| IDSS T _J =25°C | Zero Gate Voltage Drain Current | V _{DS} =65V, V _{GS} =0V | | | 1 | μA |
| IDSS T _J =100°C | | | | | 100 | |
| VGS(th) | Gate-Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 1.2 | 1.7 | 2.5 | V |
| RDS(on) | Drain-Source On-Resistance ⁴ | V _{GS} =10V, I _D =20A | - | 6.5 | 8.5 | mΩ |
| RDS(on) | Drain-Source On-Resistance ⁴ | V _{GS} =4.5V, I _D =10A | - | 8.5 | 12 | mΩ |
| gfs | Forward Transconductance ⁴ | V _{DS} = 10V, I _D = 10A | - | 80 | - | S |
| Ciss | Input Capacitance | V _{DS} =30V, V _{GS} =0V, f =1MHz | - | 1156 | - | pF |
| Coss | Output Capacitance | | - | 348 | - | |
| Crss | Reverse Transfer Capacitance | | - | 19.8 | - | |
| R _g | Gate Resistance | f=1MHz | - | 1.5 | - | Ω |
| Q _g | Total Gate Charge | V _{GS} =10V, V _{DS} =30V, I _D =20A | - | 20.6 | - | nC |
| Q _{gs} | Gate-Source Charge | | - | 3.7 | - | |
| Q _{gd} | Gate-Drain Charge | | - | 4.3 | - | |
| td(on) | Turn-On Delay Time | V _{GS} =10V, V _{DD} =30V, R _G = 3Ω, I _D =20A | - | 6.9 | - | ns |
| t _r | Rise Time | | - | 8.1 | - | |
| td(off) | Turn-Off Delay Time | | - | 18.6 | - | |
| t _f | Fall Time | | - | 5.3 | - | |
| trr | Body Diode Reverse Recovery Time | I _F =20A, dI/dt=100A/μs | - | 34 | - | ns |
| Q _{rr} | Body Diode Reverse Recovery Charge | | - | 17 | - | nC |
| VSD | Diode Forward Voltage ⁴ | I _S =20A, V _{GS} = 0V | - | - | 1.2 | V |
| I _S | Continuous Source Current | T _A =25°C | - | - | 80 | A |

Note

- 1、The data tested by surface mounted on a 1 inch² FR-4 board with 20Z copper.
- 2、The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3、The EAS data shows Max. rating . The test condition is VDD=48V,VGS=10V,L=0.1mH,IAS=29A
- 4、The power dissipation is limited by 150°C junction temperature
- 5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation

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Typical Characteristics

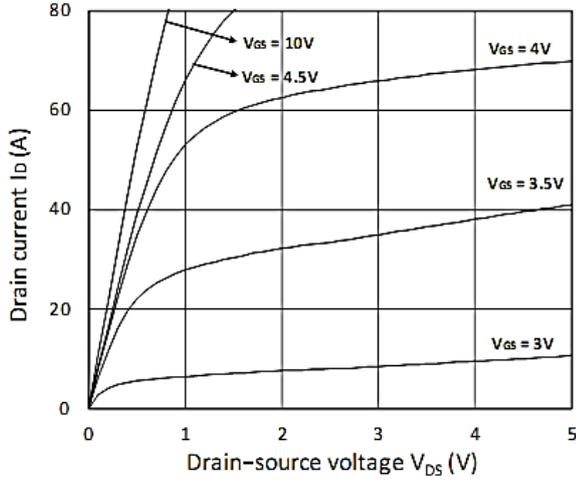


Figure 1. Output Characteristics

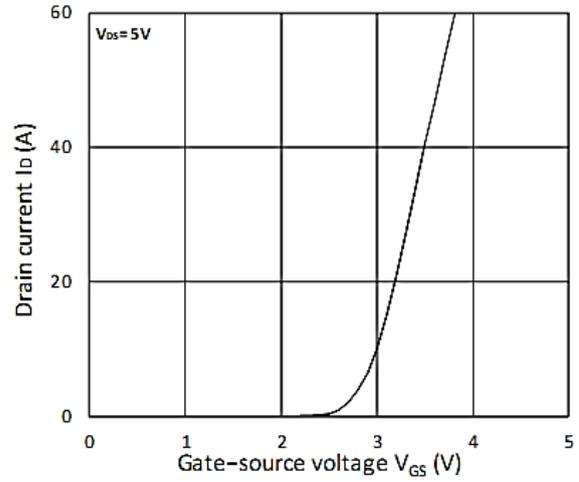


Figure 2. Transfer Characteristics

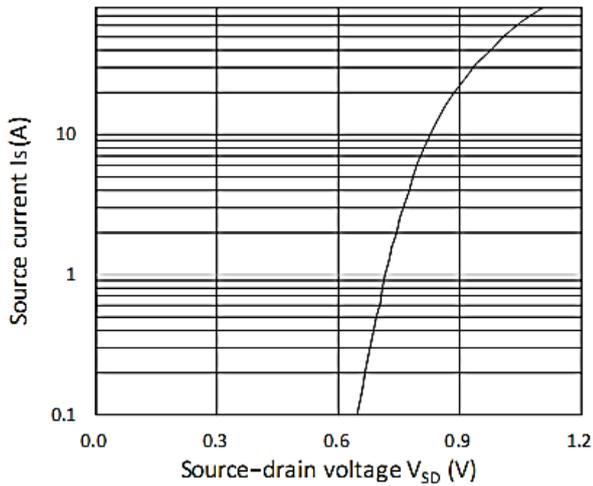


Figure 3. Forward Characteristics of Reverse

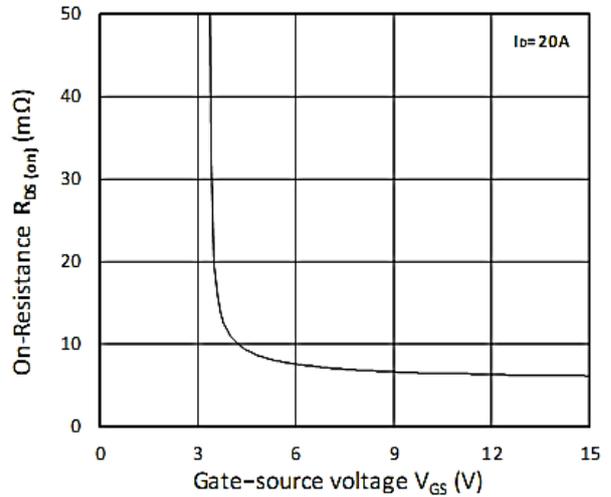


Figure 4. RDS(ON) vs. VGS

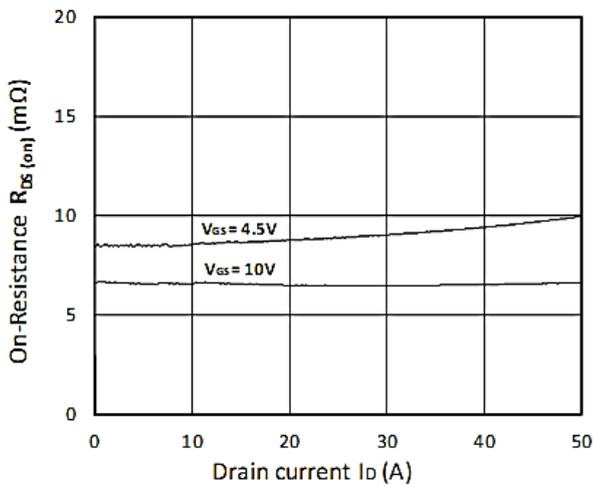


Figure 5. RDS(ON) vs. ID

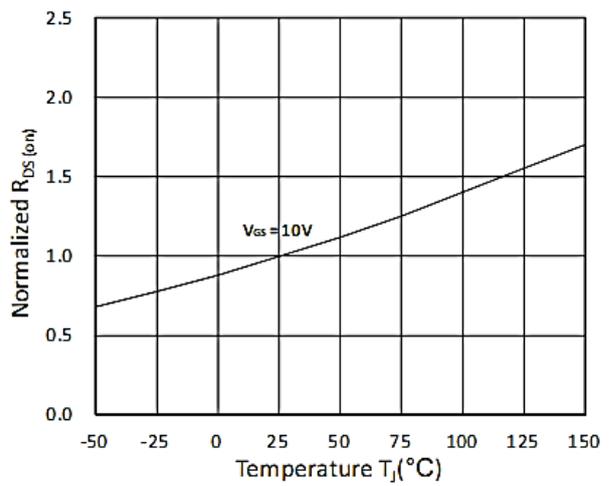


Figure 6. Normalized RDS(on) vs. Temperature

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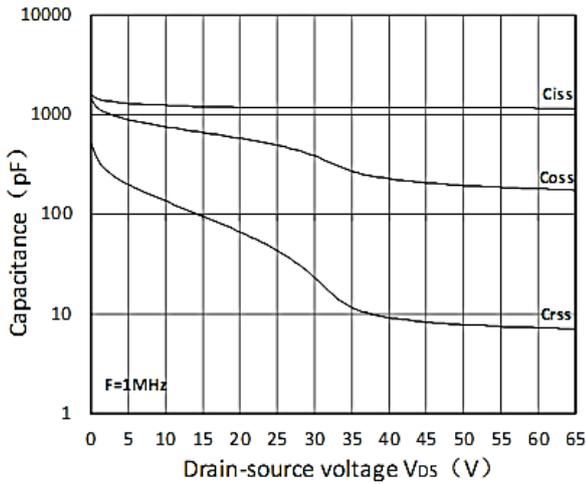


Figure 7. Capacitance Characteristics

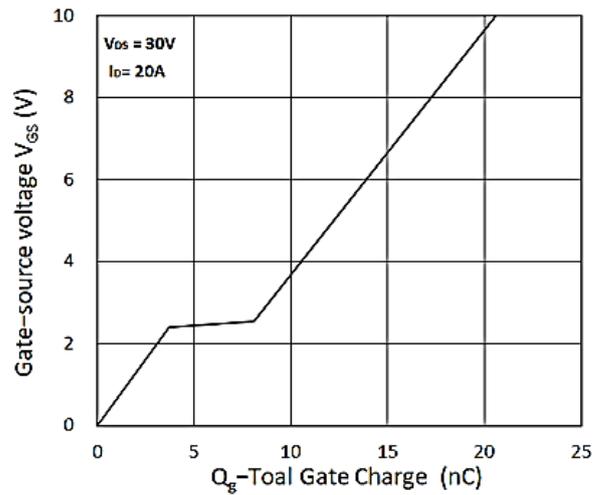


Figure 8. Gate Charge Characteristics

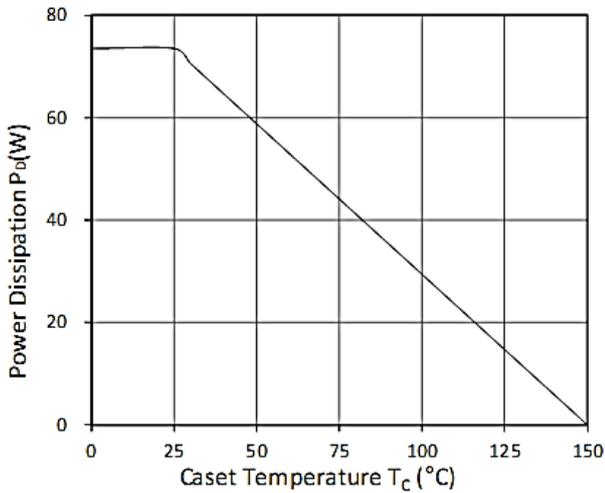


Figure 9. Power Dissipation

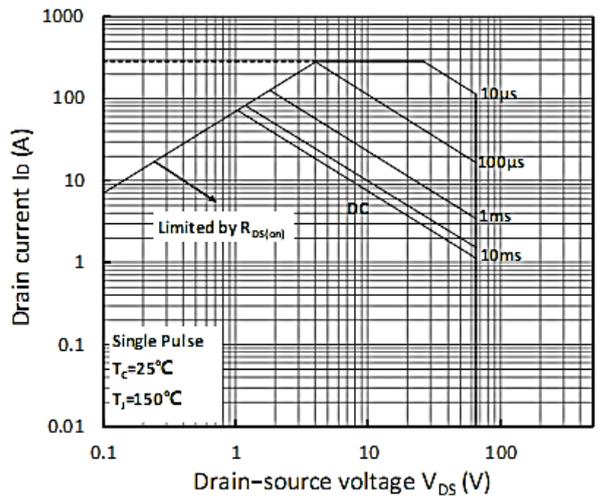


Figure 10. Safe Operating Area

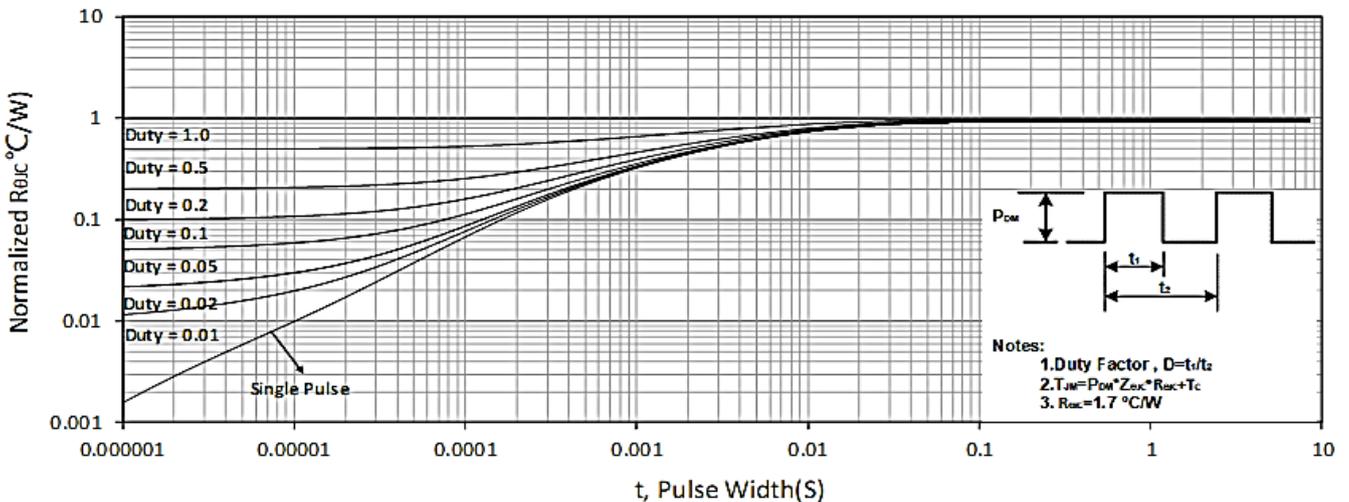
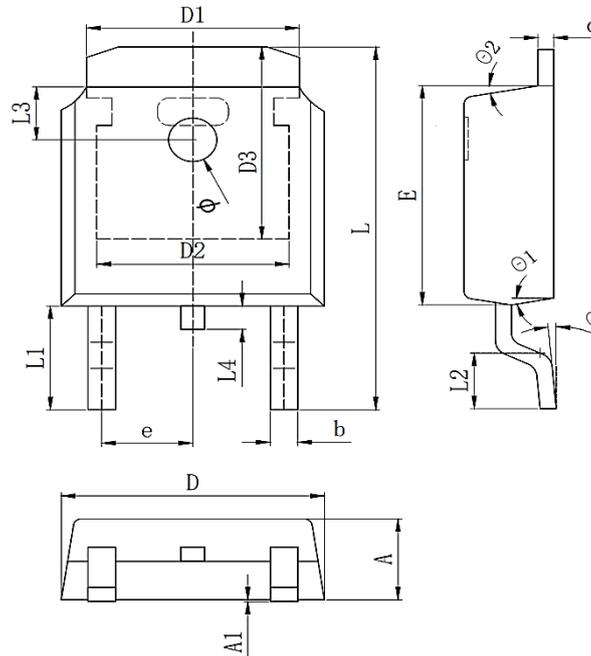


Figure 11. Normalized Maximum Transient Thermal Impedance

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Package Mechanical Data-TO-252-3L



| Symbol | Dim in mm | | |
|--------|-----------|-------|-------|
| | Min | Typ | Max |
| A | 2.1 | 2.3 | 2.5 |
| A1 | 0 | 0.064 | 0.128 |
| b | 0.64 | 0.75 | 0.86 |
| c | 0.45 | 0.52 | 0.6 |
| D | 6.4 | 6.6 | 6.8 |
| D1 | 5.33REF | | |
| D2 | 4.83REF | | |
| D3 | 5.25REF | | |
| E | 5.9 | 6.1 | 6.3 |
| e | 2.286TYP | | |
| L | 9.8 | 10.1 | 10.4 |
| L1 | 2.888REF | | |
| L2 | 1.4 | 1.5 | 1.7 |
| L3 | 1.65REF | | |
| L4 | 0.6 | 0.8 | 1 |
| φ | 1.1 | 1.2 | 1.3 |
| θ | 0° | | 10° |
| θ1 | 5° | | 10° |
| θ2 | 5° | | 10° |

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| Edition | Date | Change |
|---------|-----------|-----------------|
| REV1.0 | 2019/1/31 | Initial release |
| REV1.1 | 2024/6/15 | Reduce RDS(on) |

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